

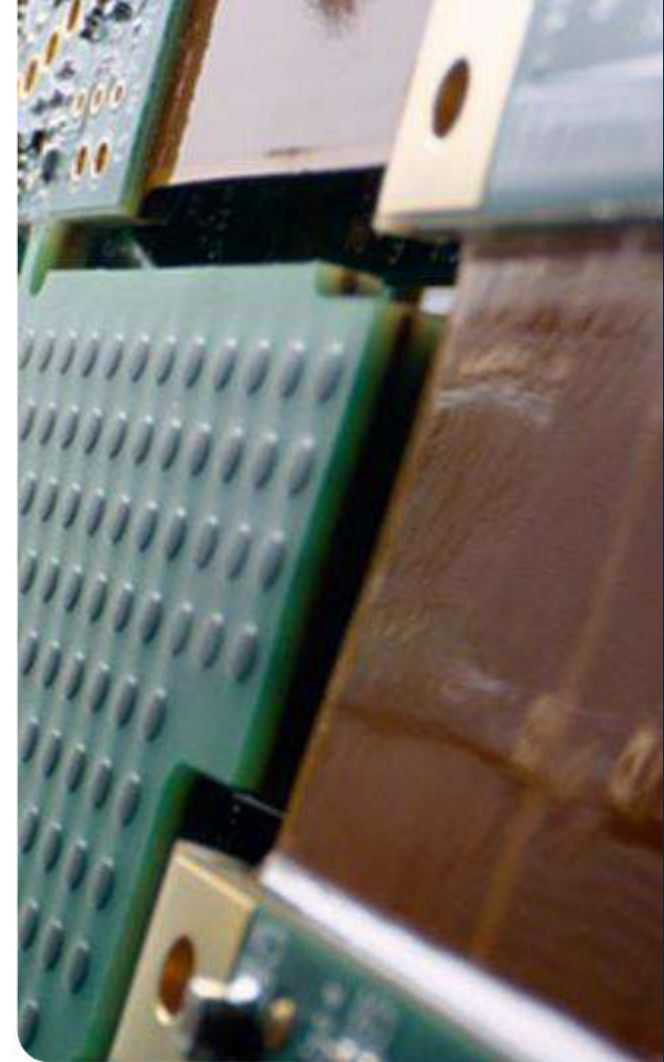
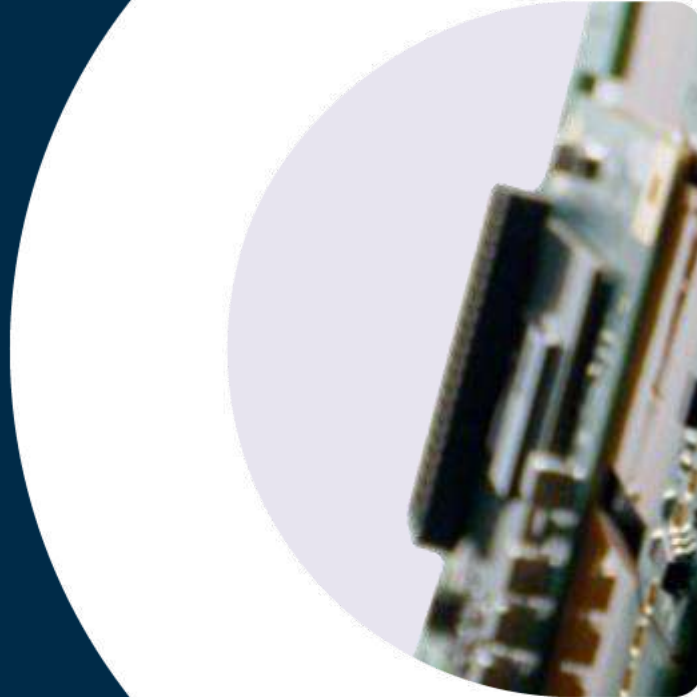


PCB All-in-One Solutions

Q2 2025

Company Presentation

August 2025



Forward looking statement

Disclaimer

The information contained herein is a summary only, and does not exhaust all the information about the Company or its operations, nor does it replace a review of the Company's Periodical or Annual Reports, or any other information which is filed and furnished with the Israel Securities Authority.

Material information regarding the Company which is included in this slide presentation has been published to the public in the past as part of the Company's reporting. That said, the information or data presented may be presented in a different manner and/or segmentation from those previously furnished in the Company's Reports.

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PCB TECHNOLOGIES at a Glance

Providing All-in-One, Cutting-Edge Hardware Electronics Technology

Legacy:

Since 1981
HQ is in Israel
788 employees

Innovation:

Strong R&D and Engineering Team
New Products - 25% of Total Revenue
+100 customers programs

Diversified Customer Base: (2024)

50% Defense and Aerospace
23% Industrial Instruments
27% Medical

Market Opportunity Growth CAGR% 2025-2030:

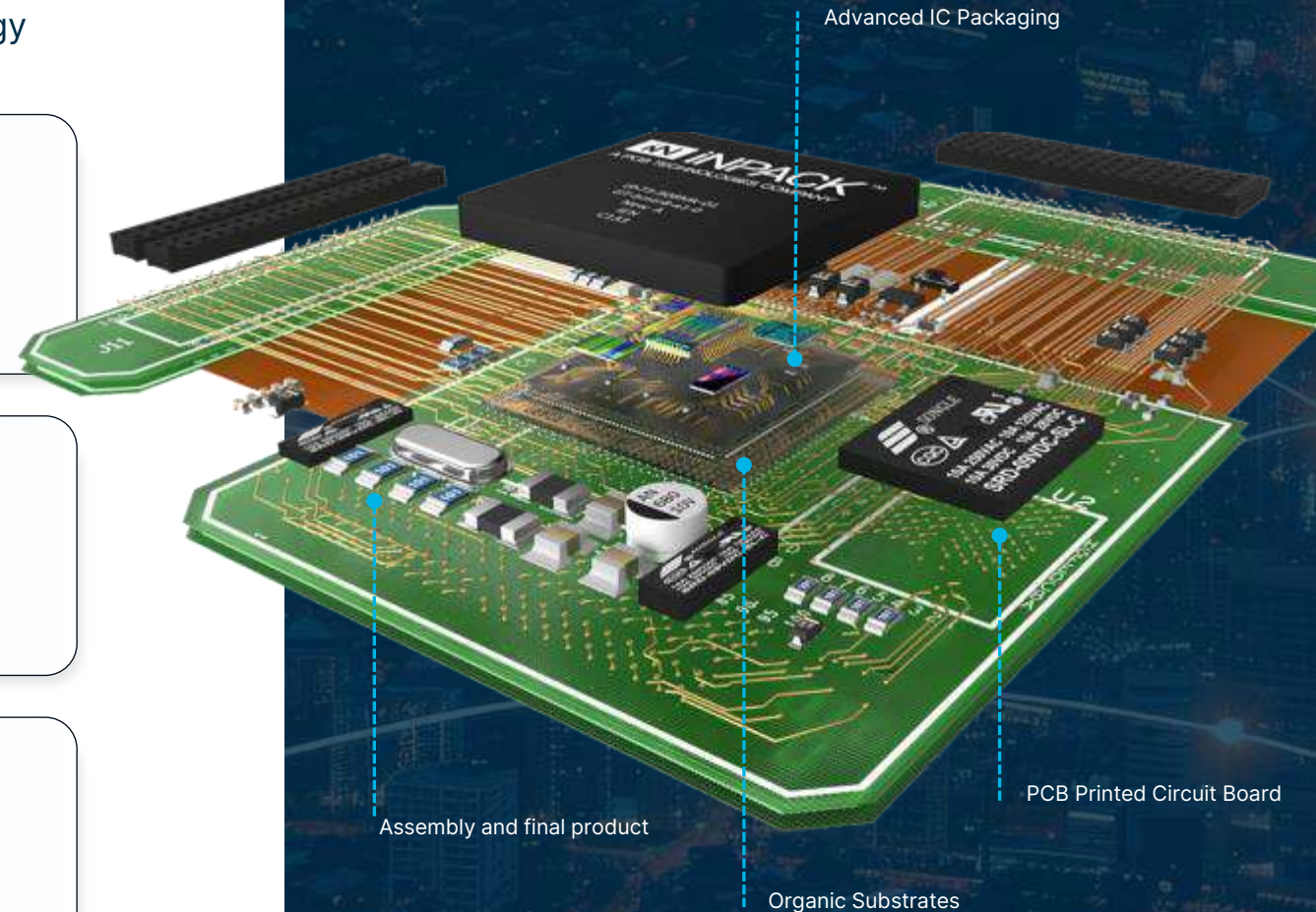
Defense and Aerospace 6.1% - 8.5%
Industrial Instruments 5.8% - 6.1%
Medical 5.6% - 6.3%

Performance

(Q2-23 > Q2-25):
TTM Revenue– 169 M\$
CAGR Sales TTM : 12.3%
CAGR GP TTM : 61.5%
CAGR EBITDA TTM : 120%

Value Proposition:

One Site, All-in-One Solution:
Bridging PCB Fabrication,
IC Packaging and Final
Product Integration



Sources: Yole, Mordor Intelligence

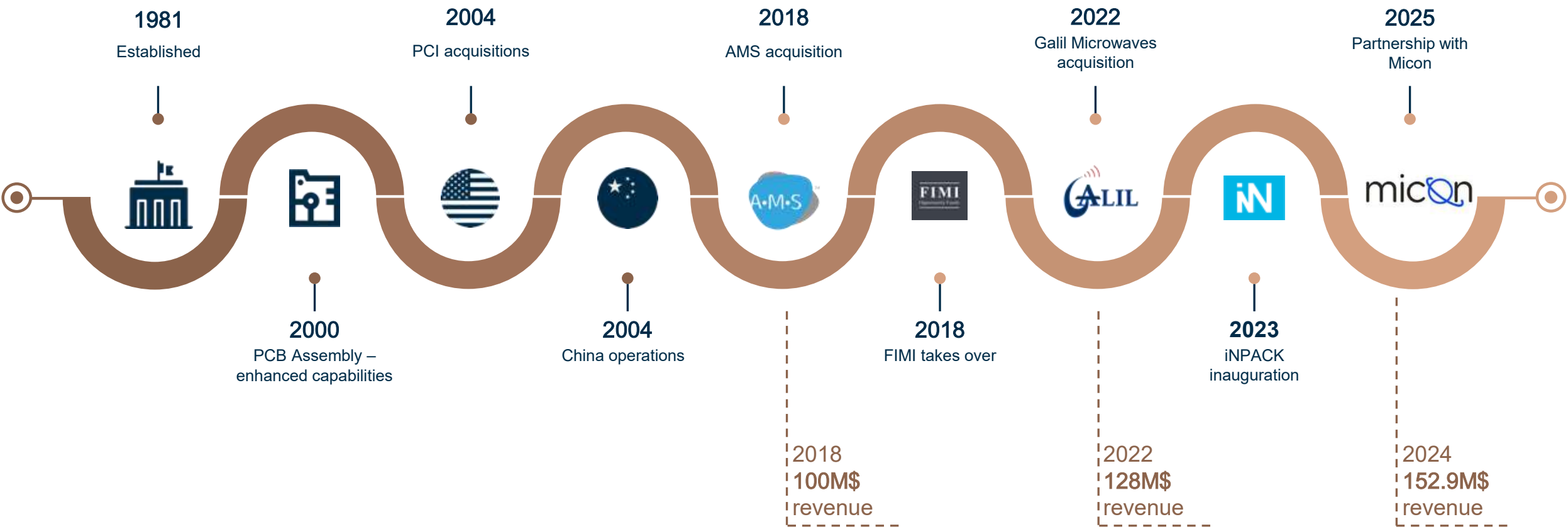


All in One Solutions

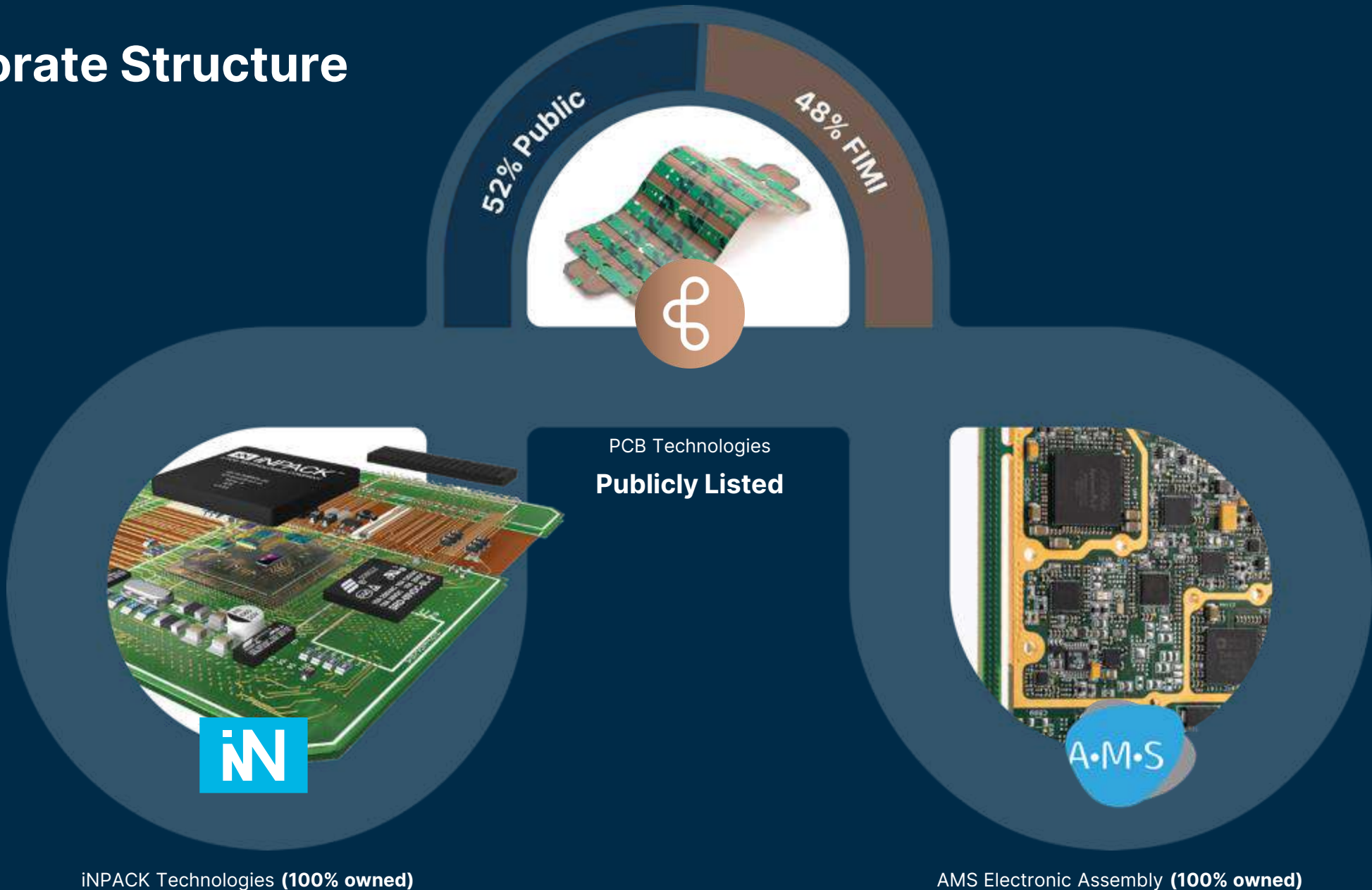
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3

Company History

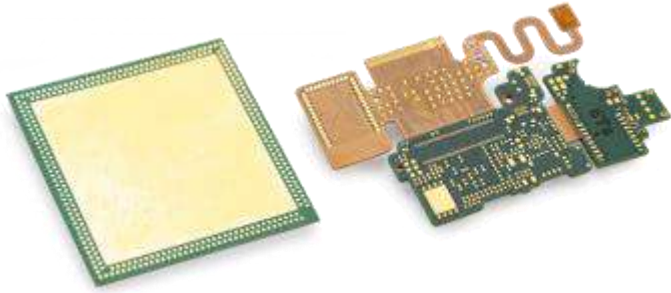


Corporate Structure



High-End Technologies

PCB Technologies Ltd. solutions enabling the most advanced electronics applications & technologies



PCBs & Substrates (Circuits Division)

- Printed circuit boards designed to support the most complex, high-density and powerful systems.
- Substrate design & manufacturing enabling high-performance solutions for analog, digital and high power.



IC Packaging (iNPACK Division)

- Complete design & manufacturing solution for the semiconductor industry.



PCBA & Final Product (Assembly Division)

- Comprehensive solutions from sub-assemblies to the final product, delivering precision and reliability for every electronics application.



... to enable High-End Applications

PCB Technologies Ltd. solutions enabling the most advanced electronics applications & technologies



Defense



Medical



Radar



ADAS



Drones



Medical

PCBs & Substrates



Industrial Instruments



Aerospace

IC Packaging



RF Communication



Medical (Miniaturization)

PCBA + Final Product



Aggrotech



Defense



Providing Solutions for Leading Defense & Aerospace Programs



Optical Seeker - Navigation system



Eitan APC -
Radar System



Iron DOME -
Missile Program



Arrow 3 -
Antennas

OVER 100 PROGRAMS:

Providing PCB Solutions:

- High Frequency
- High Reliability
- High Power

Performance, durability & long life,
even in harsh conditions, serving:

- Top Tactical OEMs
- Military Branches & Intl. Ministries of Defense
- Commercial Space Applications & more



F35 -
Communication System



Active Protection -
Radar System



Aircraft Program
Landing & Comm. System



Impacting Medical Device Technology That Can Change Lives

END-TO-END FULL ASSEMBLY SOLUTION:

Utilizing our All-in-One
Methodology for
complete, complex
Medical Devices -
starting from PCB right
through to final product
assembly.



PCB Technologies
is ISO 13485 certified.



**Cardiac Navigation -
Complete System**



PCBA for MRI system



**Respiratory Monitoring -
Complete System**



Creating Precision Industrial Instruments for Complex Challenges

ALWAYS UP ON TECH:

Offering innovative solutions that provide both products and entire systems for a wide range of critical industrial sectors, including:
Semiconductor
Aggrotech, National Utility
Grids and the latest
Space-age Satellite
Communications Systems.



PCBA for 5G Satellites



Aggrotech Drones - Complete System



Water Meter Equipment - Complete System



Semiconductor - Heat Management control



Markets Mega Trends

Aerospace & Defense



Miniaturization



Integrated Systems



Laser Systems



Satellite-based Operations

Medical Technologies



Miniaturization



Telemedicine



3D Printing



Cybersecurity

Industrial Instrumentation



Hyperscale's



ML



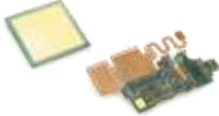


LLM's



Generative AI



End-Market Growth Drivers & Outlook

Segment	Company Share from 2024 Revenue	US+EU Total *EMS Market Size 2024 (B\$)	 PCB & Substrate Market Size(B\$)	 IC Packaging Market Size (B\$)	 Assembly & Final Product Market Size (B\$)	Company Addressable Market 2024 (B\$)	Segment CAGR % (2025-2030)
Aerospace & Defense	50%	45	5	2	38	7.2	6.1%--8.5%
Medical Technologies	23%	32	3	2	27	3.7	5.8%--6.1%
Industrial Instruments	27%	41	4	2	35	4.7	5.6%--6.3%
Total		118	12	6	100	15.6	

*Electronic Manufacturing Services

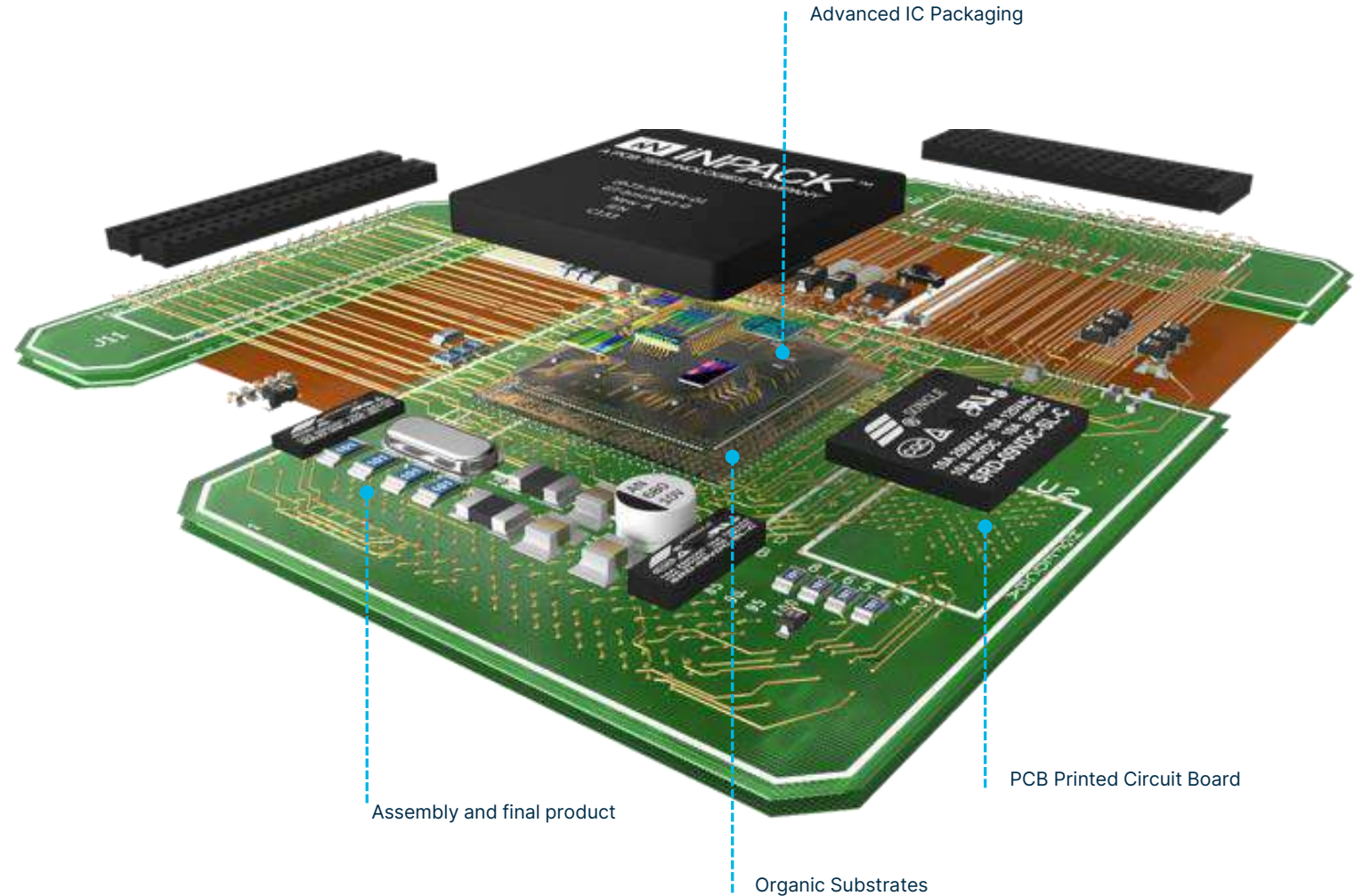
Sources: Mordor Intelligence, K.B.V Research



Unique ONE-STOP SHOP for integrated cutting-edge Hardware Electronics Manufacturing

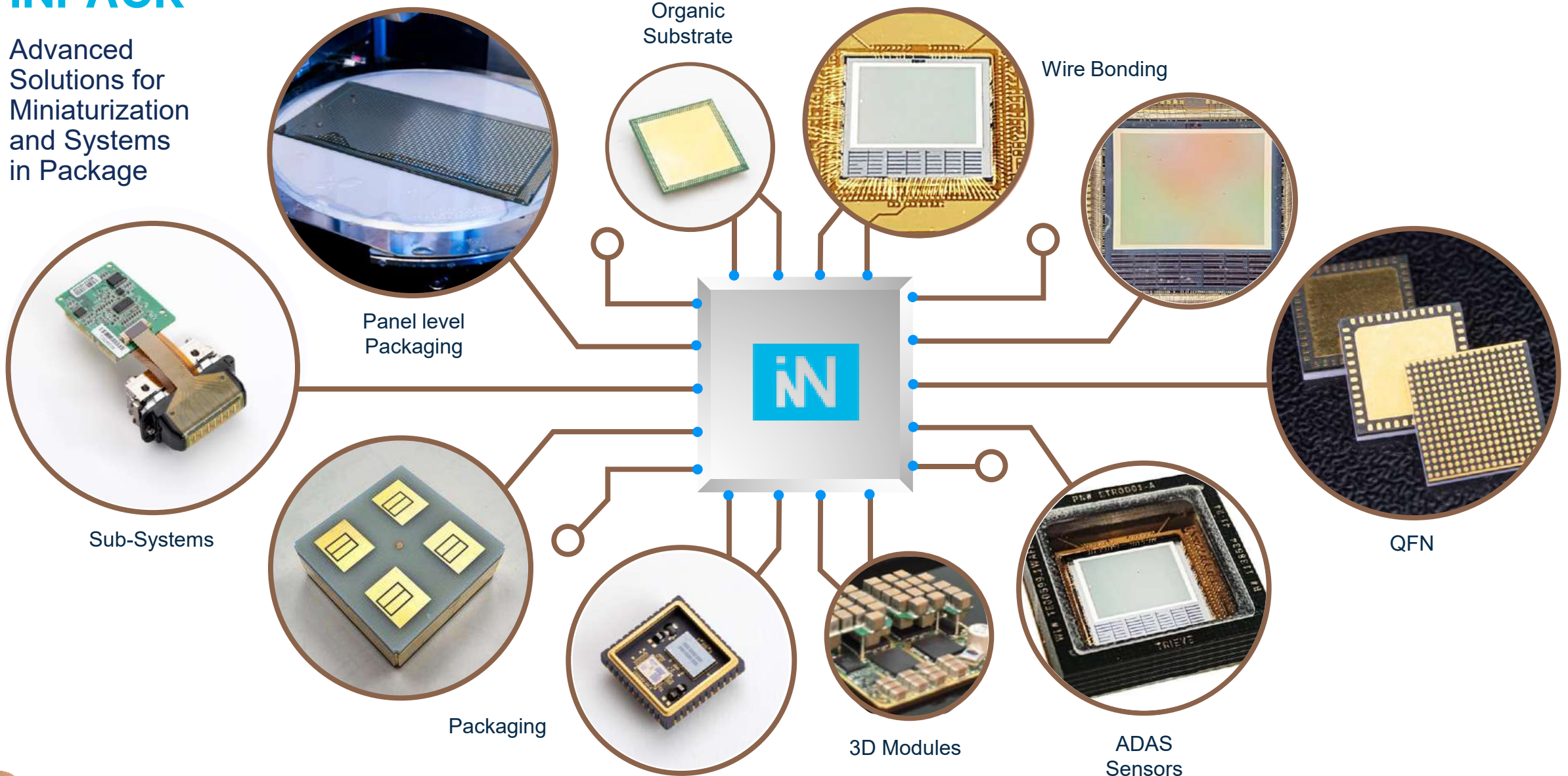
Added Value to Customers:

- ✓ Improved time to market
- ✓ Better yield processes
- ✓ More flexibility in design
- ✓ Smarter customization
- ✓ Lower development costs
- ✓ From prototype to mass production



iNPACK

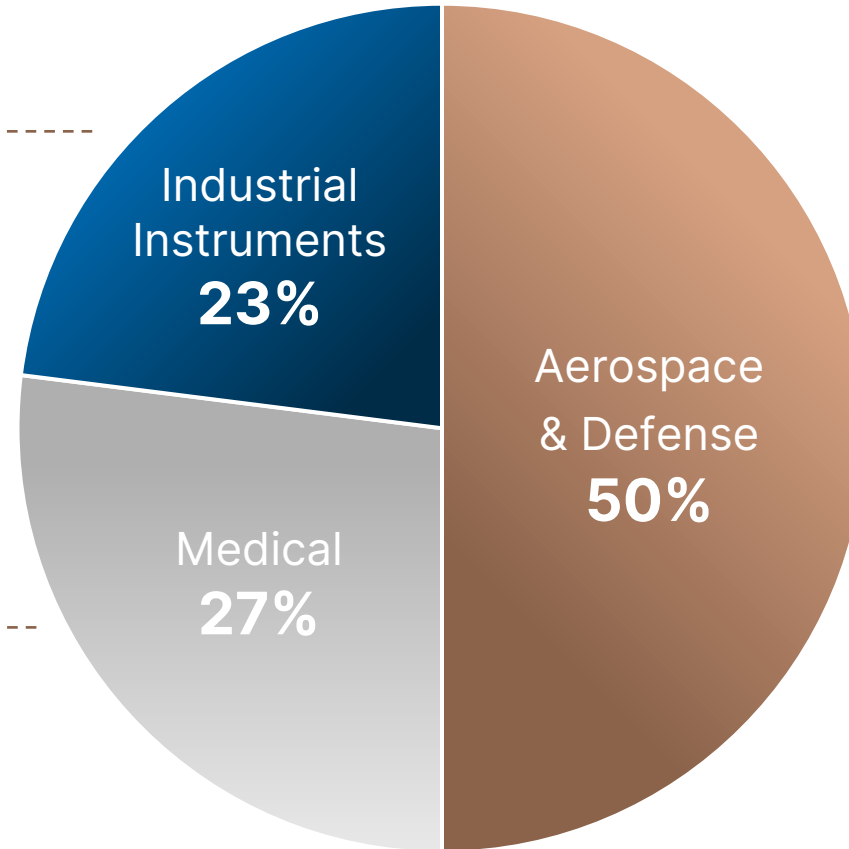
Advanced
Solutions for
Miniaturization
and Systems
in Package





Key Business Highlights

Diversified end-market mix with a growing Aerospace & Defense segment

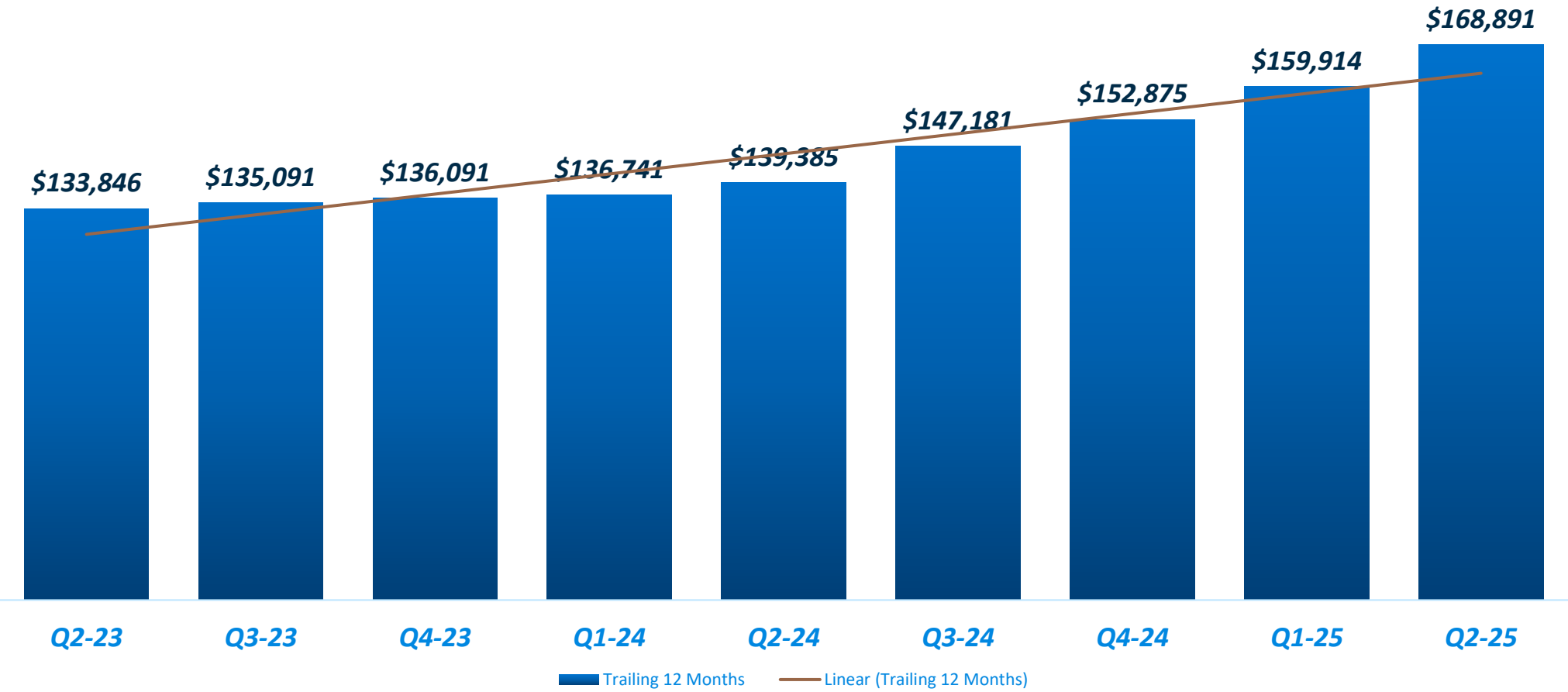


Based on 2024 \$152M Sales By Main Industries



Sales Trend K\$

Sales CAGR: 12.3%



Consistent Growth in Sales



Consolidate EBITDA & GP Trends K\$

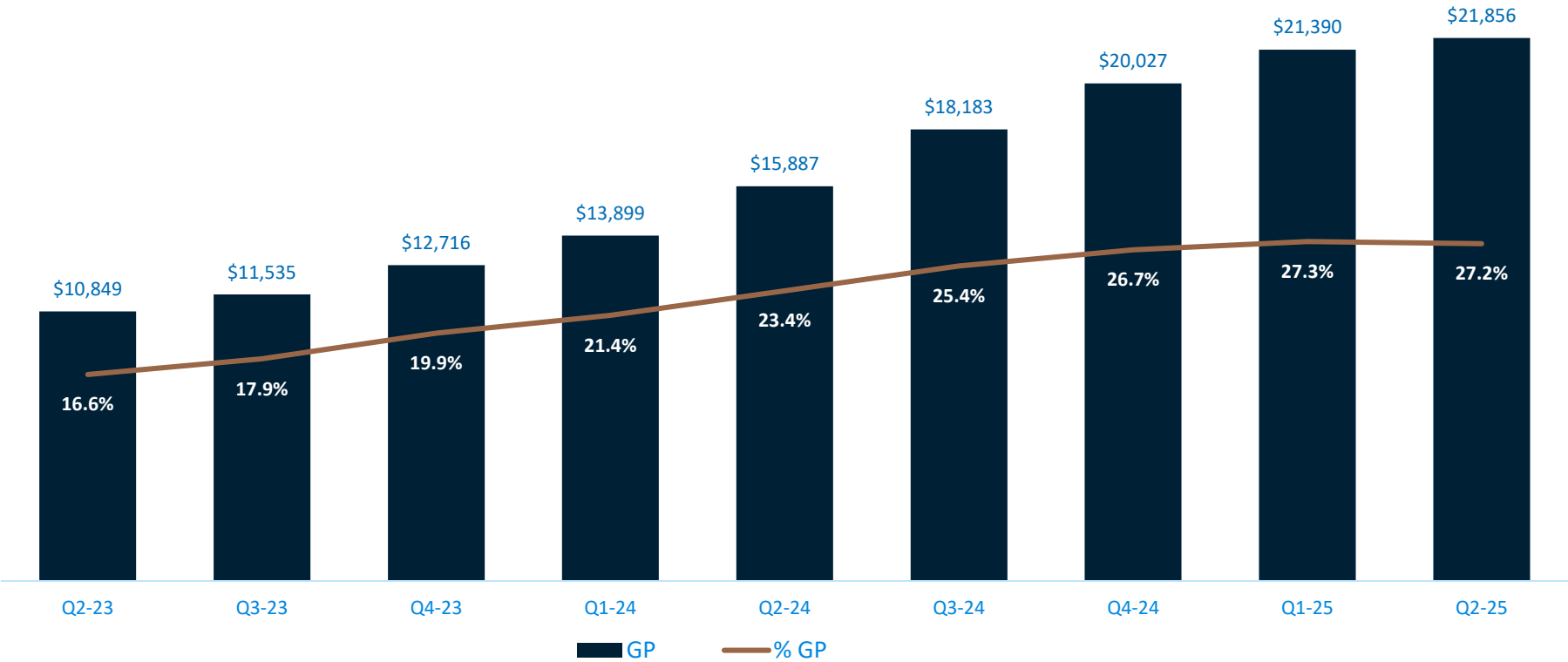


CAGR GP TTM Q2-23>>Q2-25: 61.5%
CAGR EBITDA TTM Q2-23>>Q2-25: 120%

Ongoing improvement in operational efficiency and product mix



Circuits Division TTM GP K\$ Trend

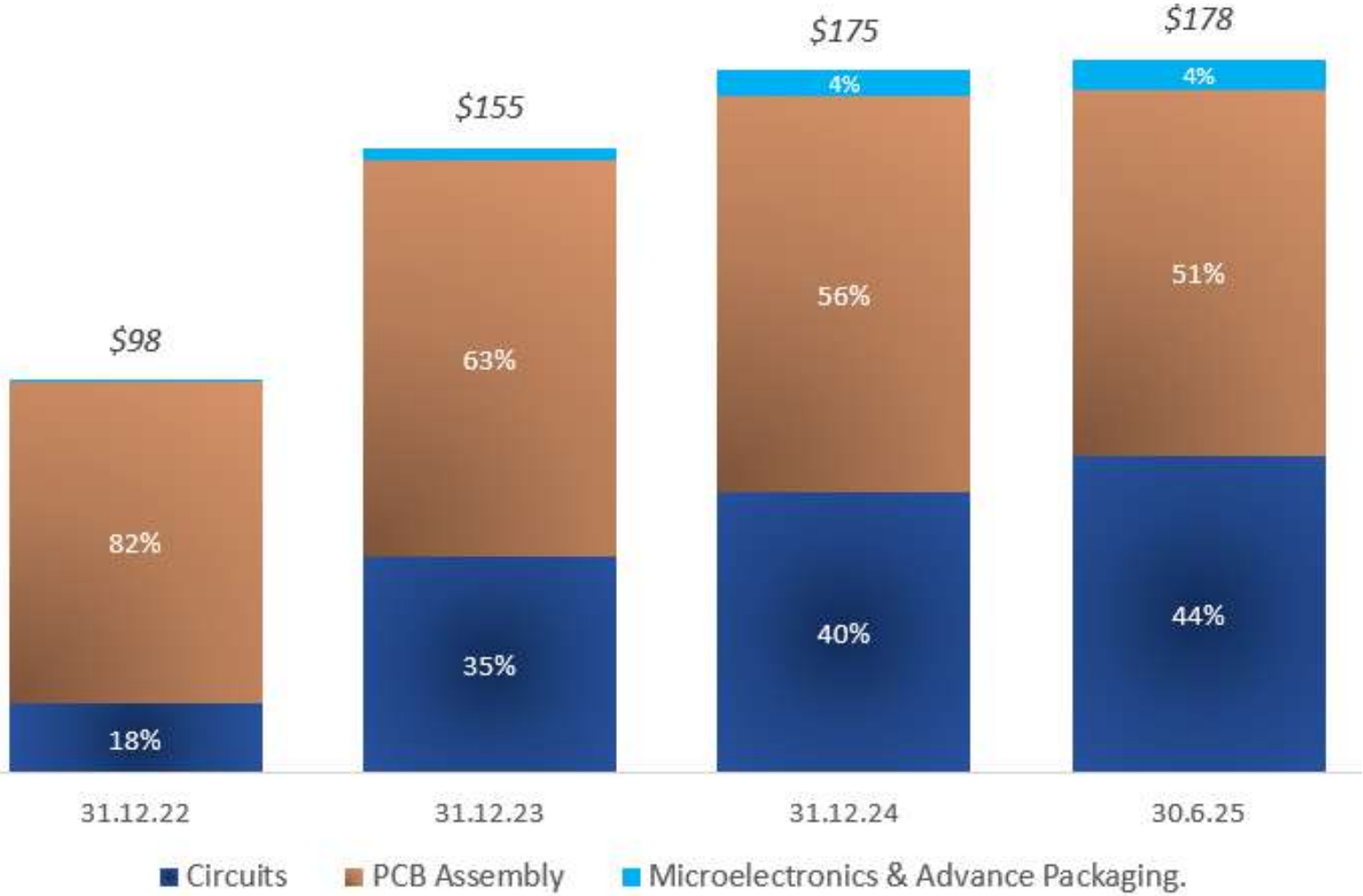


CAGR GP TTM Q2-23 >> Q2-25: 42%

Double GP by product mix and revenue stream, driven by our proprietary technology and strong OEM partnerships



Backlog & Long Term Agreements (LTA) M\$

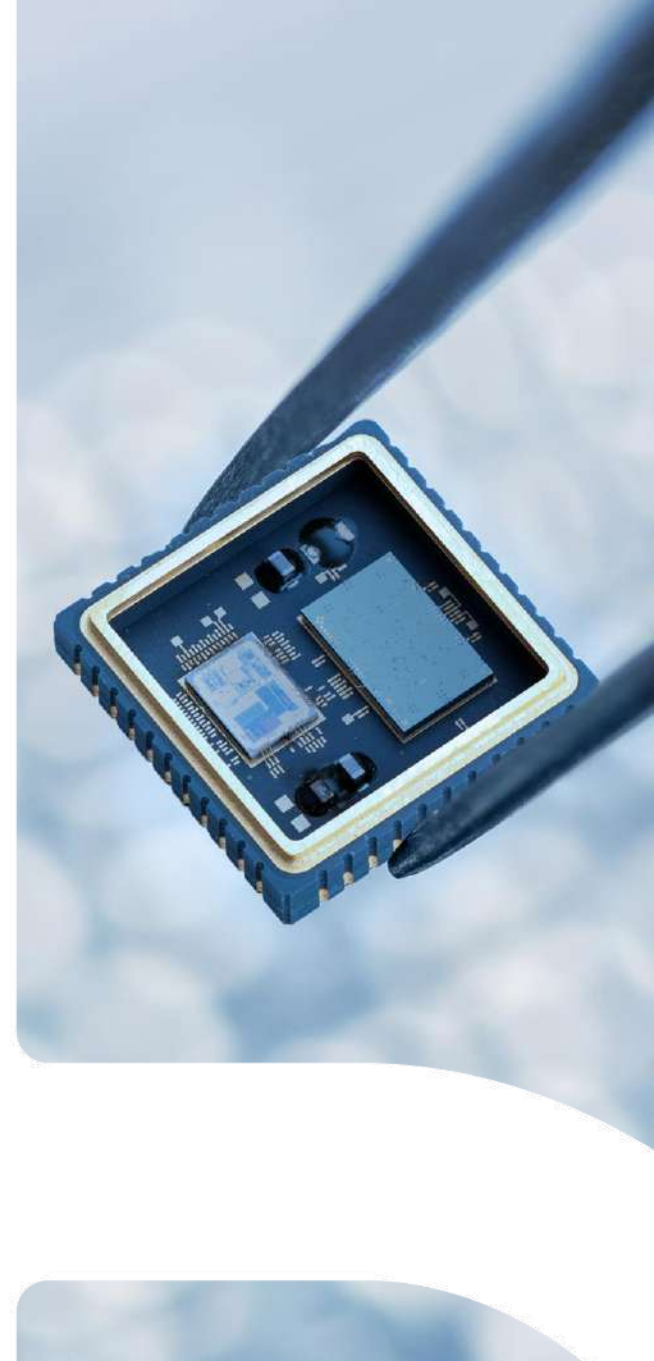


Information presented in this chart is based on dates adjacent to the release of the financial statements



Our Path Forward -Continued Growth

- A **strong backlog** ensures continued revenue growth across all divisions.
- We are **involved in major programs** within the Defense & Aerospace, Medical, and Industrial Instruments sectors, serving key customers.
- The current **business climate**, influenced by geopolitical tensions, **drives demand** for advanced hardware electronics solutions in the Western market.
- Our **product mix emphasizes advanced technologies and miniaturization**, contributing to profit improvement.
- We are **expanding our capacity** through capital expenditures to address production bottlenecks and enhance operational efficiency.



Thank You

